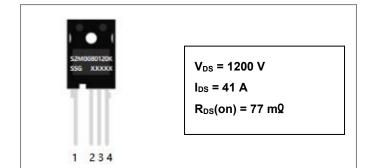


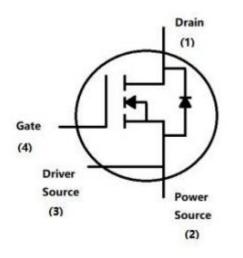
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S2M0080120K 1200V SIC POWER MOSFET



Circuit Diagram



Description

S2M0080120K is single SiC Power MOSFET packaged in TO-247-4 case. The device is a high voltage n-channel enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S2M0080120K is ideal for energy sensitive, high frequency applications in challenging environments.

Features

- Positive temperature characteristics, easy to parallel.
- Low on-resistance Typ. RDS(on) = 77mΩ .
- Fast switching speed and low switching losses.
- Very fast and robust intrinsic body diode.
- Process of non-bright Tin electroplatin

Applications

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)

Characteristics Symbol Condition Max. Units 1200 V Drain Source Voltage VDSS V_{GS} = 0V, I_{DS} = 100uA, T_{C} = 25°C Gate Source Voltage V_{GSS} Tc = 25 ° C, Absolute maximum values, AC -10 to +25 V (f>1Hz) Gate Source Voltage VGSOP T_c = 25°C Recommended Operational Values -5 to +20 V **Continuous Drain Current** $V_{GS} = 20V, T_C = 25^{\circ}C$ I_D 41 А I_D $V_{GS} = 20V, T_{C} = 100^{\circ}C$ 29 А Tc=25°C Pulsed Drain Current 82 А ID,pulse T_c=25°C 231 Power Dissipation P_{D} W

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Maximum Ratings(T=25°C unless otherwise specified)



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Electrical Characteristics(T=25°C unless otherwise specified)

Characteristics	Symbol	Condition	Min.	Тур.	Max.	Unit s	
Drain Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0V, I _D = 1mA	1200			V	
	$V_{\text{GS(th)}}$	V_{DS} = V_{GS} , I_D = 10mA	2.0	2.8	4.0	V	
Gate Threshold Voltage		V _{DS} = V _{GS} , I _D = 10mA, T _J = 175 °C		1.8		V	
	IDSS	V _{DS} = 1200V, V _{GS} = 0V		0.1	1.0	uA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 1200V, V _{GS} = 0V, T _J = 175 °C		1		uA	
	I _{GSS+}	V _{GS} = 20V, V _{DS} = 0V		10	100	nA	
Gate Source Leakage Current	I _{GSS-}	V _{GS} = -5V, V _{DS} = 0V		-10	-100	nA	
Drain Source On-State	P	V _{GS} = 20V, I _D = 20A		77	100	mΩ	
Resistance	R _{DS(on)}	V _{GS} = 20V, I _D = 20A, T _J = 175 °C		137		mΩ	
Transcenductores	gfs	V _{DS} = 20 V, I _D = 20 A		10.5		s	
Transconductance		V _{DS} = 20 V, I _D = 20 A, T _J = 175 °C		8		s	
Input Capacitance	Ciss	s V _{GS} = 0V,		1324			
Output Capacitance	Coss	V _{DS} = 1000V		74		pF	
Reverse Transfer Capacitance	C _{RSS}	V _{AC} = 25mV		3.4			
Coss Stored Energy	Eoss	f = 200kHz		37		uJ	
Turn-On Switching Energy	E _{ON}	V _{DS} = 800V, V _{GS} = -5/20V		290			
Turn-Off Switching Energy	EOFF	I_D = 20A, $R_{G(ext)}$ = 2.5 Ω		20		uJ	
Turn-On Delay Time	t _{d(on)}	V _{DS} = 800V, V _{GS} = -5/20V		20			
Rise Time	tr	I _D = 20A, R _{G(ext)} = 2.5Ω, L=975uH		11		ns	
Turn-Off Delay Time	$t_{d(off)}$	FWD=GP2T080A120U		20			
Fall Time	t _f			7.8			
Internal Gate Resistance	R _{G(int)}	f = 1MHz, VAC = 25 mV, D-S short		3.3		Ω	
Gate to Source Charge	Q_{gs}	V _{DS} = 800V, V _{GS} = -5/20V		23			
Gate to Drain Charge	Q_{gd}	I _D = 20A		14		nC	
Total Gate Charge	Qg			54			



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Reverse Diode Characteristics:

Characteristics	Symbol	mbol Condition		Max.	Units
Diode Forward Voltage	V _{SD}	V _{GS} = -5V, I _{SD} = 10A			V
	V _{SD}	V _{GS} = -5V, I _{SD} = 10A, T _J = 175°C	3.5		V
Continuous Diode Forward Current	ls	V _{GS} = -5V, T _C = 25℃		41	А
Reverse Recovery Time	t _{rr}	V _{GS} = -5V, I _{SD} = 20A, T _J = 25°C			ns
Reverse Recovery Charge	Qrr	V _R = 800V	102		nC
Peak Reverse Recovery Current	I _{mm}	dif/dt= 1950A/µs	6.7		А

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	$R_{ ext{ heta}JC}$	DC operation	0.65	°C/W
Typical Thermal Resistance Junction to Ambient	R _{θJA}		32	°C/W

Ordering Information:

Device	Package	Shipping
S2M0080120K	TO-247-4	25pcs/tube

Marking Diagram



Where XXXXX is YYWWL

```
S2M
        = Device Type
```

0080 = R_{DS}(on) 120

= Reverse Voltage (1200V) = Package

- κ SSG = SSG
- YΥ = Year ww

L

- = Week
- = Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

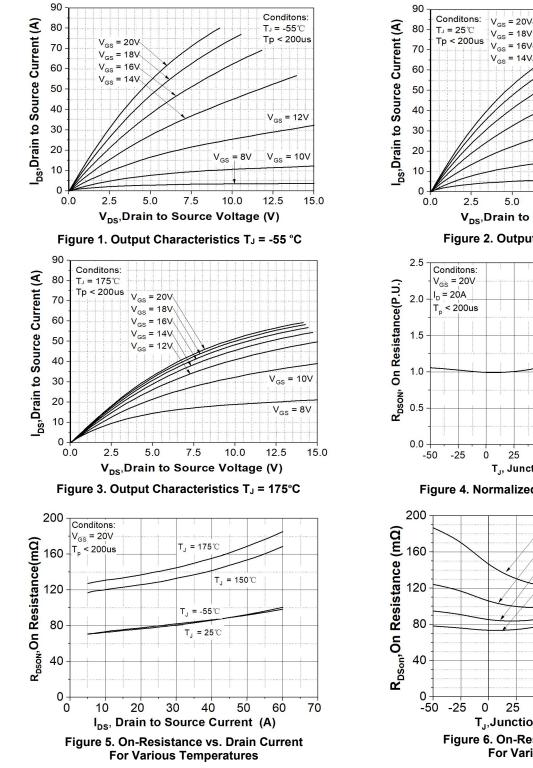
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Ratings and Characteristics Curves



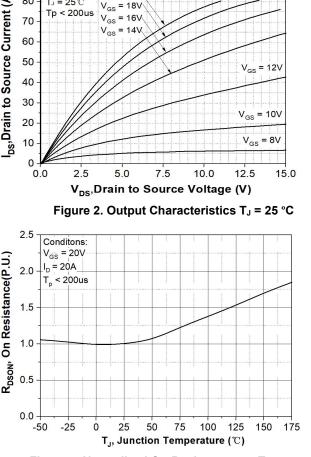
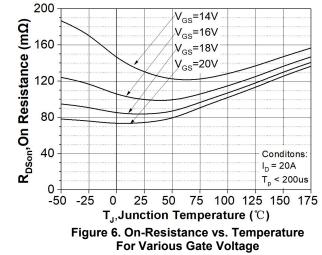


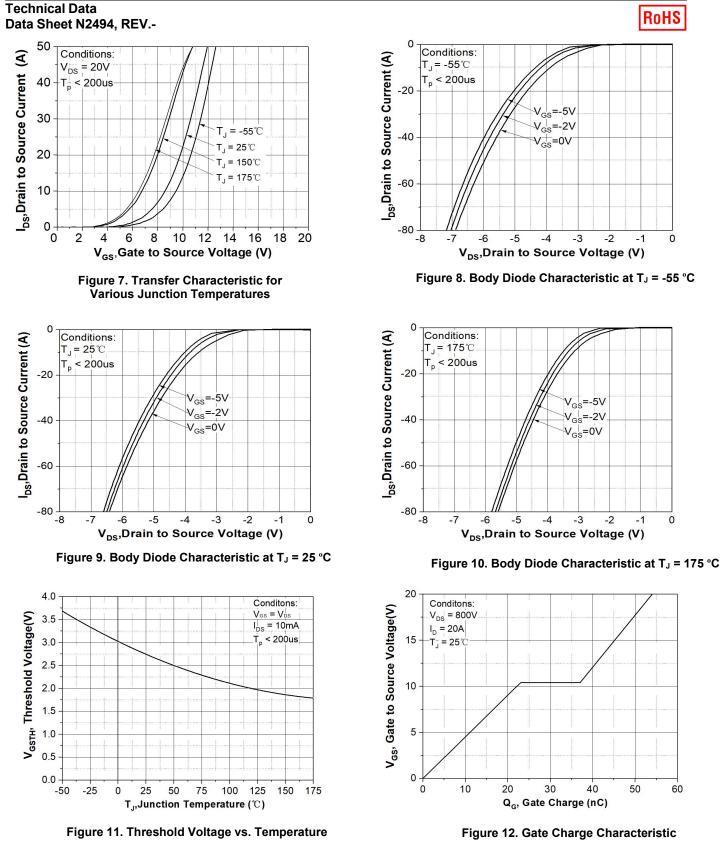
Figure 4. Normalized On-Resistance vs. Temperature



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10000

1000

100

10

1

Ö

C,Capacitance (pF)

S2M0080120K

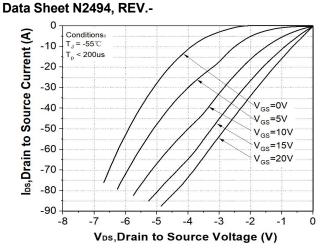
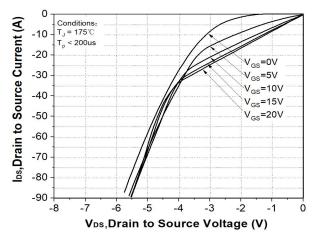


Figure 13. 3rd Quadrant Characteristic at T_J = -55 °C



Ciss

Coss

Crss

50

Figure 15. 3rd Quadrant Characteristic at T_J = 175°C

VGS=0V, f=1MHz

Crss=Cgd

Coss=Cds+Cad

Ciss=Cgs+Cgd, Cds SHORTED

150

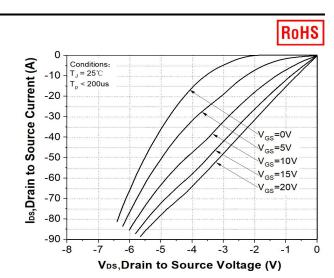


Figure 14. 3rd Quadrant Characteristic at T_J = 25 °C

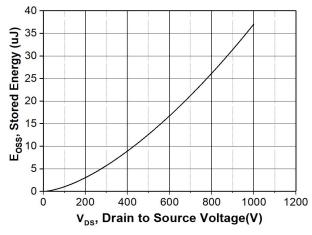
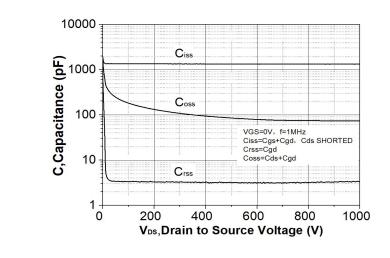
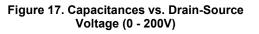


Figure 16. Output Capacitor Stored Energy





100

VDS, Drain to Source Voltage (V)

Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1000V)

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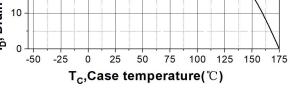
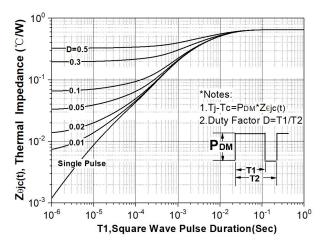
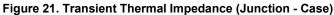


Figure 19. Continuous Drain Current Derating vs. **Case Temperature**





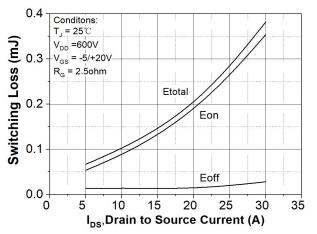


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 600V)

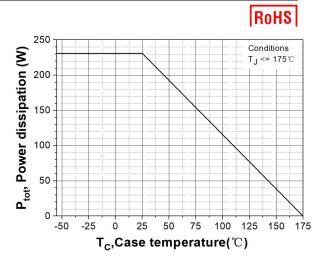


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

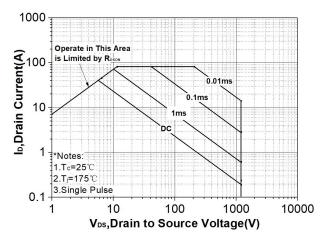
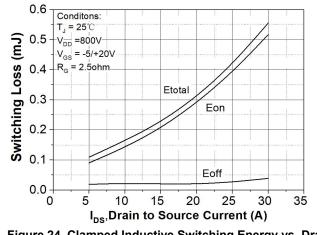
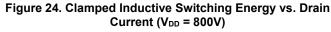
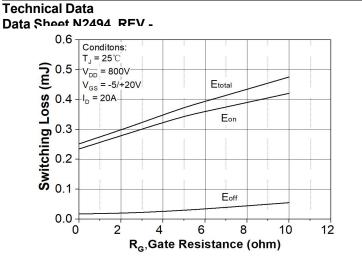


Figure 22. Safe Operating Area





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Figure 25. Clamped Inductive Switching Energy vs. R_{G(ext)}

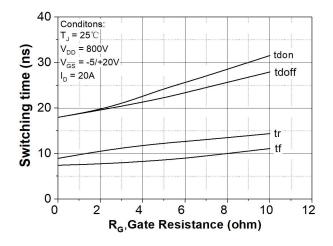


Figure 27. Switching Times vs. R_{G(ext)}

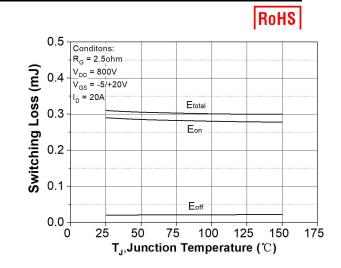


Figure 26. Clamped Inductive Switching Energy vs. Temperature

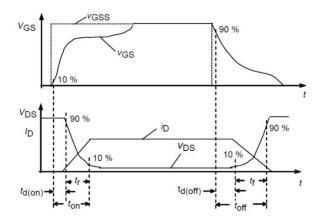


Figure 28. Switching Times Definition

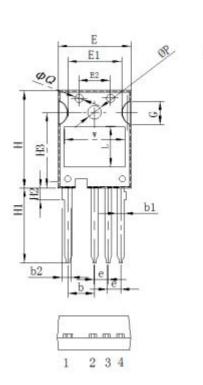


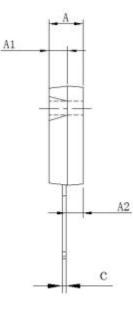
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Mechanical Dimensions TO-247-4

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Current al	In mm			
Symbol	Min	Nom	Max	
A	4.80	5.00	5.21	
A1	2.29	3.00	3.20	
A2	1.91	2.40	2.60	
b	4.80	5.05	5.25	
b1	1.05	1.25	1.60	
b2	1.07	2.30	2.65	
С	0.50	0.60	0.70	
е	2.35	2.55	2.88	
E	15.50	15.70	16.13	
E1	10.50	10.70	10.90	
E2	6.35	7.60	7.80	
G	4.80	5.00	5.20	
Н	22.40	22.60	23.60	
H1	17.31	18.50	18.70	
H2	2.50	3.00	4.37	
H3	16.00	16.50	17.35	
ΦΡ	3.00	3.60	3.80	
ΦQ	2.20	2.50	3.00	

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